

SEMiX404GB12Vs



SEMiX® 4s

SEMiX404GB12Vs

Features

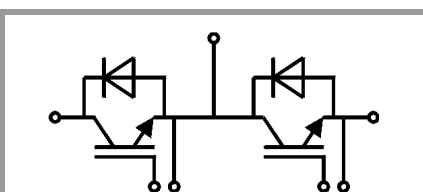
- Homogeneous Si
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability
- UL recognised file no. E63532

Typical Applications*

- AC inverter drives
- UPS
- Electronic Welding

Remarks

- Case temperature limited to $T_C=125^{\circ}\text{C}$ max.
- Product reliability results are valid for $T_J=150^{\circ}\text{C}$
- Dynamic values apply to the following combination of resistors:
 $R_{Gon,main} = 1,8 \Omega$
 $R_{Goff,main} = 1,8 \Omega$
 $R_{G,X} = 2,2 \Omega$
 $R_{E,X} = 0,5 \Omega$



GB

Absolute Maximum Ratings

Symbol	Conditions		Values	Unit
IGBT				
V _{CES}			1200	V
I _C	T _j = 175 °C	T _c = 25 °C	596	A
		T _c = 80 °C	455	A
I _{Cnom}			400	A
I _{CRM}	I _{CRM} = 3xI _{Cnom}		1200	A
V _{GES}			-20 ... 20	V
t _{psc}	V _{CC} = 600 V V _{GE} ≤ 15 V V _{CES} ≤ 1200 V	T _j = 125 °C	10	μs
T _j			-40 ... 175	°C
Inverse diode				
I _F	T _j = 175 °C	T _c = 25 °C	440	A
		T _c = 80 °C	329	A
I _{Fnom}			400	A
I _{FRM}	I _{FRM} = 3xI _{Fnom}		1200	A
I _{FSM}	t _p = 10 ms, sin 180°, T _j = 25 °C		1980	A
T _j			-40 ... 175	°C
Module				
I _{t(RMS)}	T _{terminal} = 80 °C		600	A
T _{stg}			-40 ... 125	°C
V _{isol}	AC sinus 50Hz, t = 1 min		4000	V

Characteristics

Symbol	Conditions	min.	typ.	max.	Unit
IGBT					
$V_{CE(sat)}$	$I_C = 400 \text{ A}$ $V_{GE} = 15 \text{ V}$ chipelevel	$T_J = 25^{\circ}\text{C}$	1.75	2.2	V
		$T_J = 150^{\circ}\text{C}$	2.2	2.5	V
V_{CE0}		$T_J = 25^{\circ}\text{C}$	0.94	1.04	V
		$T_J = 150^{\circ}\text{C}$	0.88	0.98	V
r_{CE}	$V_{GE} = 15 \text{ V}$	$T_J = 25^{\circ}\text{C}$	2.0	2.9	$\text{m}\Omega$
		$T_J = 150^{\circ}\text{C}$	3.3	3.8	$\text{m}\Omega$
$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C = 16 \text{ mA}$	5.5	6	6.5	V
I_{CES}	$V_{GE} = 0 \text{ V}$ $V_{CE} = 1200 \text{ V}$	$T_J = 25^{\circ}\text{C}$	0.1	0.3	mA
		$T_J = 150^{\circ}\text{C}$			mA
C_{ies}	$V_{CE} = 25 \text{ V}$ $V_{GE} = 0 \text{ V}$	$f = 1 \text{ MHz}$	24.0		nF
C_{oes}		$f = 1 \text{ MHz}$	2.36		nF
C_{res}		$f = 1 \text{ MHz}$	2.36		nF
Q_G	$V_{GE} = -8 \text{ V...} + 15 \text{ V}$		4400		nC
R_{Gint}	$T_J = 25^{\circ}\text{C}$		1.88		Ω
$t_{d(on)}$	$V_{CC} = 600 \text{ V}$ $I_C = 400 \text{ A}$	$T_J = 150^{\circ}\text{C}$	517		ns
t_r	$V_{GE} = \pm 15 \text{ V}$	$T_J = 150^{\circ}\text{C}$	94		ns
E_{on}	$R_{Gon} = 2.5 \Omega$	$T_J = 150^{\circ}\text{C}$	39.1		mJ
$t_{d(off)}$	$R_{Goff} = 2.5 \Omega$	$T_J = 150^{\circ}\text{C}$	788		ns
t_f	$di/dt_{on} = 4200 \text{ A}/\mu\text{s}$ $di/dt_{off} = 3600 \text{ A}/\mu\text{s}$	$T_J = 150^{\circ}\text{C}$	102		ns
E_{off}	$du/dt_{off} = 6800 \text{ V}/\mu\text{s}$	$T_J = 150^{\circ}\text{C}$	52.3		mJ
$R_{th(j-c)}$	per IGBT			0.075	K/W

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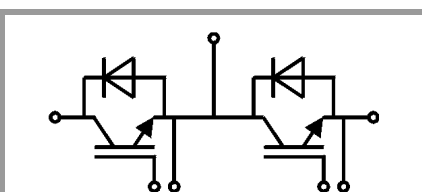
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Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
Inverse diode						
V _F = V _{EC}	I _F = 400 A	T _j = 25 °C		2.2	2.52	V
	V _{GE} = 0 V chip	T _j = 150 °C		2.1	2.5	V
V _{F0}		T _j = 25 °C	1.1	1.3	1.5	V
		T _j = 150 °C	0.7	0.9	1.1	V
r _F		T _j = 25 °C	2.0	2.3	2.5	mΩ
		T _j = 150 °C	2.6	3.1	3.4	mΩ
I _{RRM}	I _F = 400 A	T _j = 150 °C		309		A
Q _{rr}	di/dt _{off} = 4100 A/μs	T _j = 150 °C		73		μC
E _{rr}	V _{GE} = -15 V	T _j = 150 °C		34.3		mJ
	V _{CC} = 600 V					
R _{th(j-c)}	per diode				0.14	K/W
Module						
L _{CE}				22		nH
R _{CC'+EE'}	res., terminal-chip	T _C = 25 °C		0.7		mΩ
		T _C = 125 °C		1		mΩ
R _{th(c-s)}	per module			0.03		K/W
M _s	to heat sink (M5)		3		5	Nm
M _t		to terminals (M6)	2.5		5	Nm
						Nm
w					400	g
Temperatur Sensor						
R ₁₀₀	T _C =100°C (R ₂₅ =5 kΩ)			493 ± 5%		Ω
B _{100/125}	R(T)=R ₁₀₀ exp[B _{100/125} (1/T-1/T ₁₀₀)]; T[K];			3550 ±2%		K



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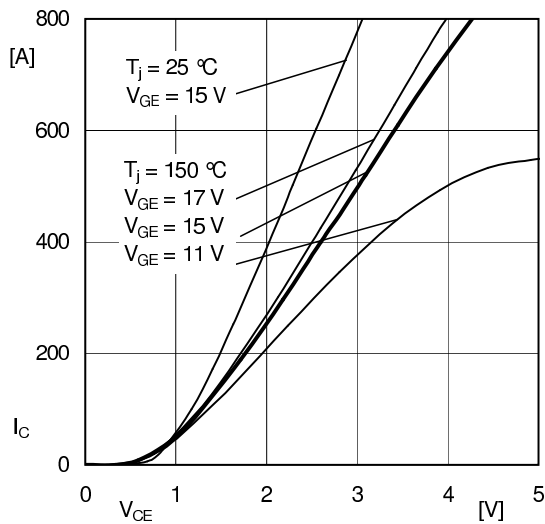


Fig. 1: Typ. output characteristic, inclusive $R_{CC'} + E_{E'}$

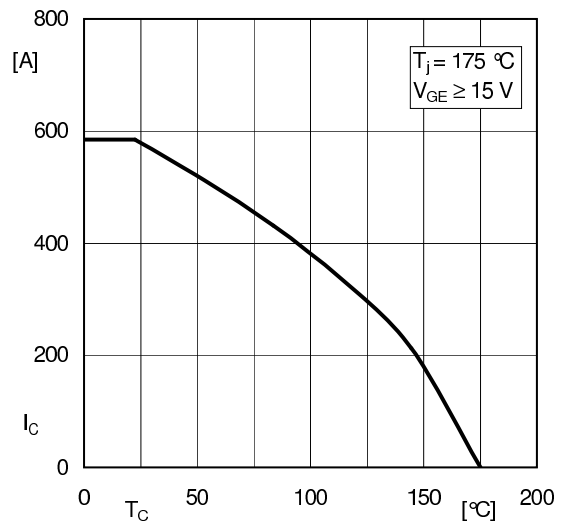


Fig. 2: Rated current vs. temperature $I_C = f(T_C)$

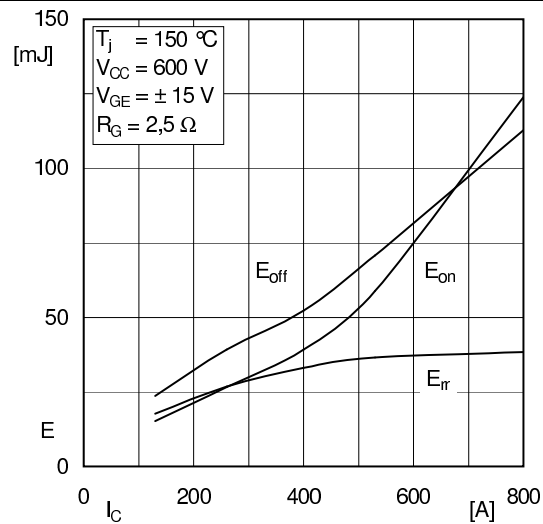


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

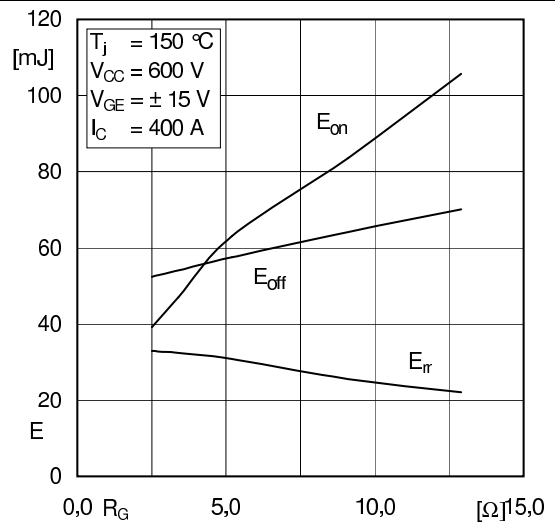


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

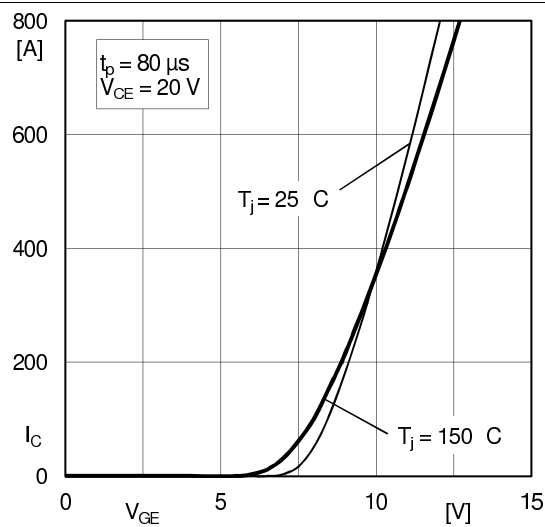


Fig. 5: Typ. transfer characteristic

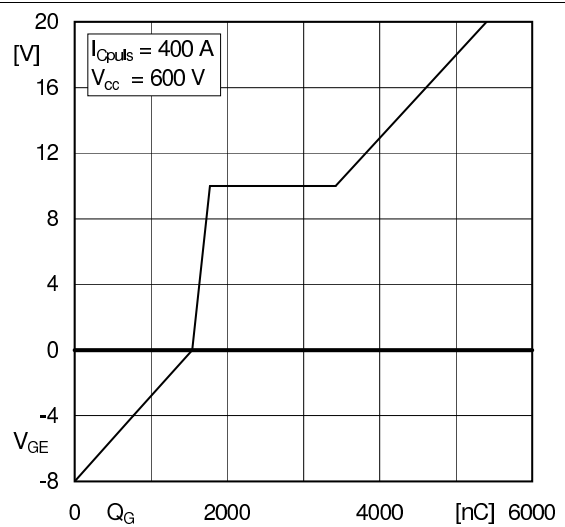
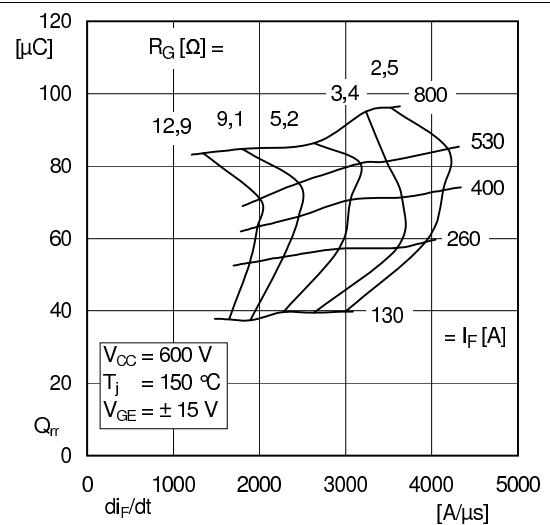
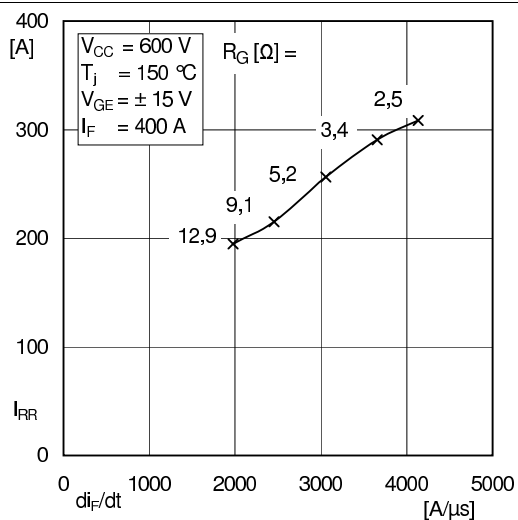
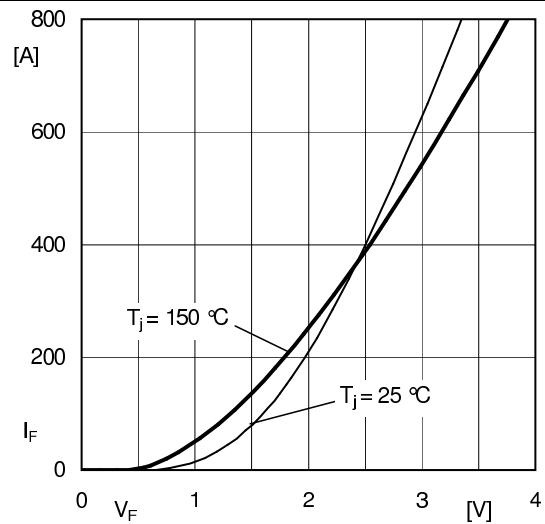
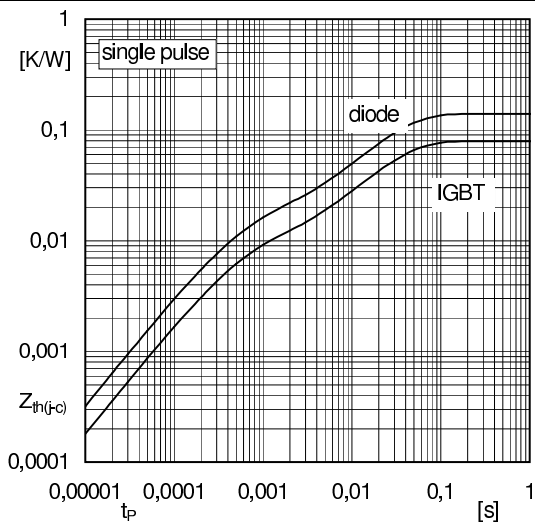
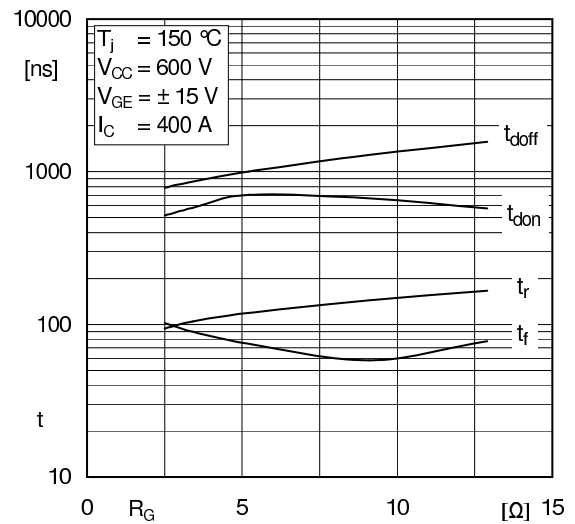
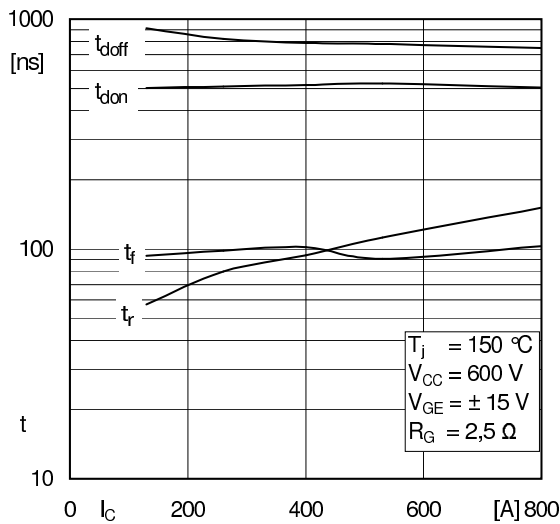
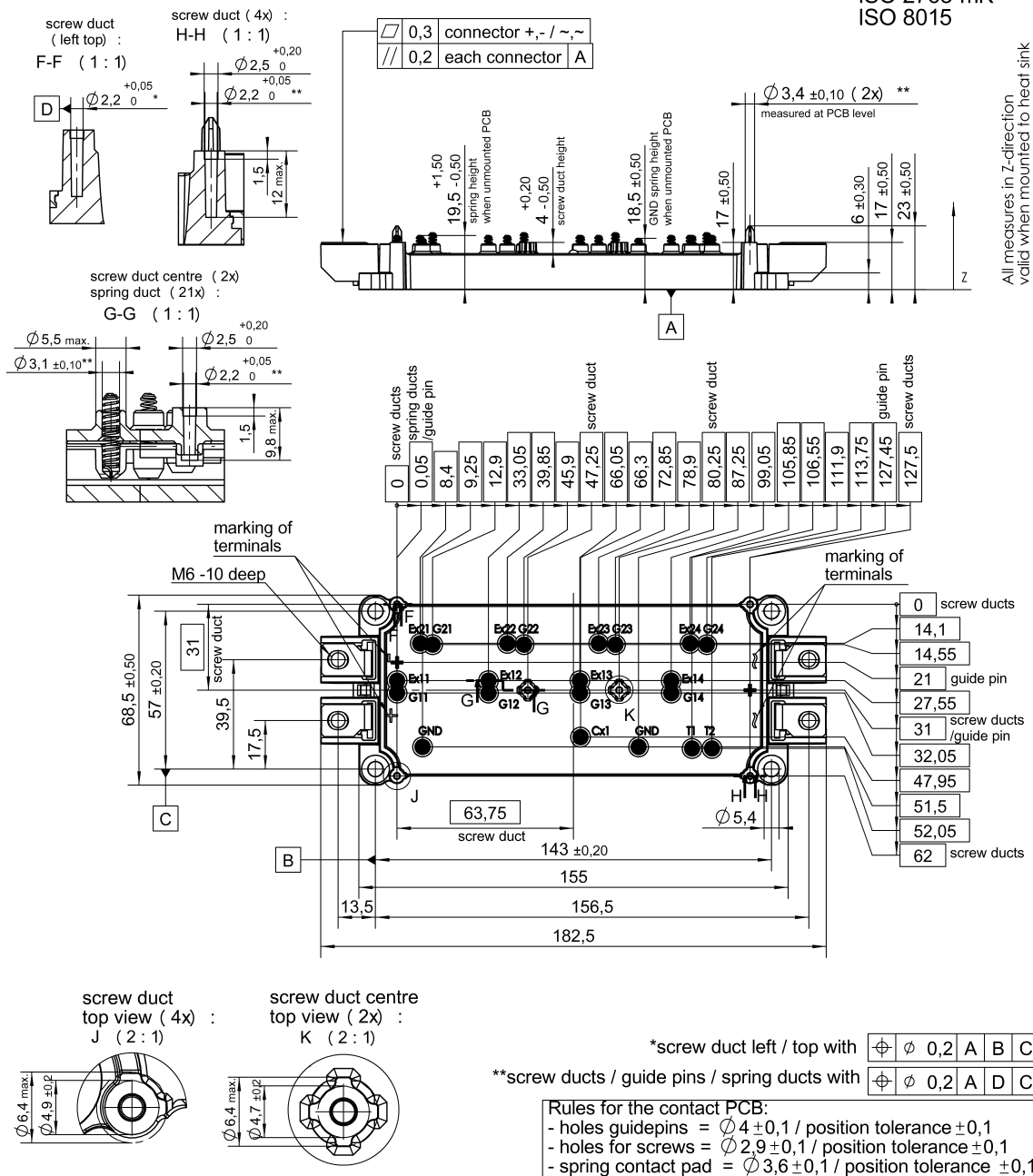


Fig. 6: Typ. gate charge characteristic

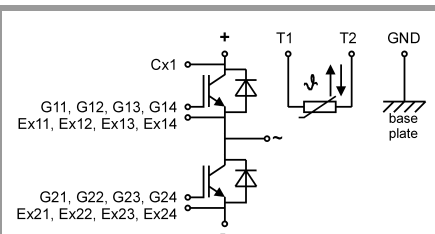


Case: SEMiX 4s

general tolerance:
ISO 2768-mK
ISO 8015



SEMiX 4s



spring configuration

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.